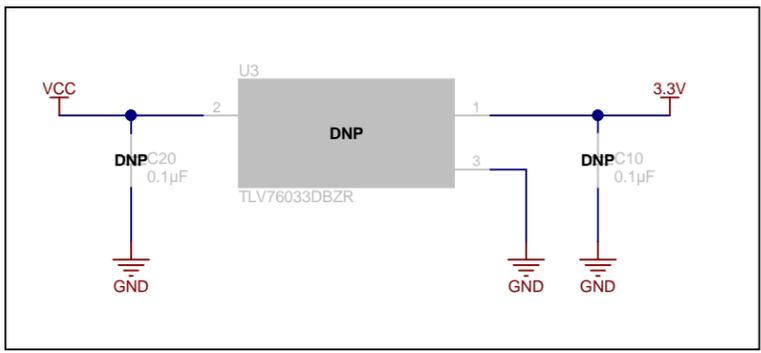
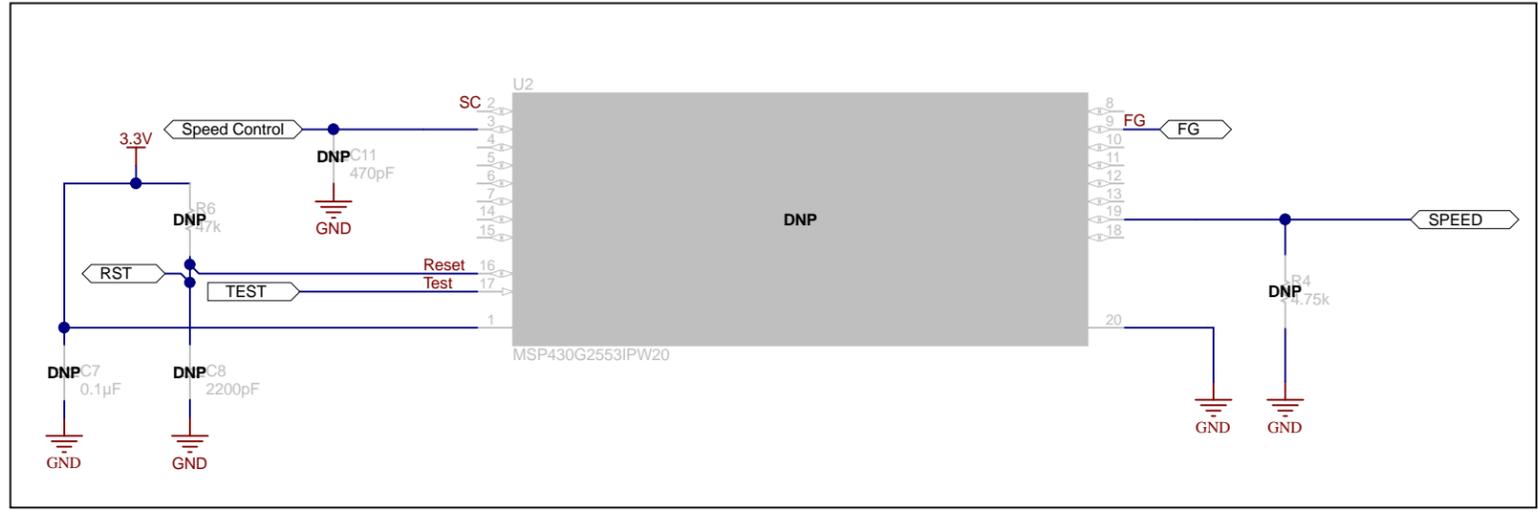


Motor Control



LDO



Speed Control with MSP430

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TID #: TIDA-01619	Project Title: Sunon Server Fan	
Number: TIDA-01619	Rev: E1	Sheet Title:
SVN Rev: Version control disabled	Assembly Variant: Do Not Populate	Sheet: 2 of 3
Drawn By:	File: Sunon Layout.SchDoc	Size: B
Engineer: Sunon Server Fan	Contact: <a href="http://www.ti.com/support">http://www.ti.com/support</a>	



PCB  
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Number: <a href="#">TIDA-01619</a>	Rev: <a href="#">E1</a>	Sheet Title:	
SVN Rev: <a href="#">Version control disabled</a>	Assembly Variant: <a href="#">Do Not Populate</a>	Sheet: <a href="#">3</a> of <a href="#">3</a>	
Drawn By:	File: <a href="#">EVM_Hardware.SchDoc</a>	Size: B	
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